

**WT41u**  
DATA SHEET  
25 April 2022  
Version 1.0.0



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## WT41u *Bluetooth®* Module

### DESCRIPTION

WT41u is a long range class 1, Bluetooth® 2.1 + EDR module. WT41u is a highly integrated and sophisticated Bluetooth® module, containing all the necessary elements from Bluetooth® radio and a fully implemented protocol stack. Therefore WT41u provides an ideal solution for developers who want to integrate Bluetooth® wireless technology into their design with limited knowledge of Bluetooth® and RF technologies. WT41u is optimized for long range applications and is available with a U.FL connector for an external antenna.

By default WT41u module is equipped with powerful and easy-to-use iWRAP firmware. iWRAP enables users to access Bluetooth® functionality with simple ASCII commands delivered to the module over serial interface - it's just like a Bluetooth® modem.

### APPLICATIONS:

- Hand held terminals
- Industrial devices
- Point-of-Sale systems
- PCs
- Personal Digital Assistants (PDAs)
- Computer Accessories
- Access Points
- Automotive Diagnostics Units

### FEATURES:

- Fully Qualified Bluetooth v2.1 + EDR end product
- CE qualified
- Modular certification for FCC, IC and KCC
- MIC Japan compatibility fully tested with ARIB STD-T66
- TX power : 18 dBm
- RX sensitivity : -92 dBm
- U.FL antenna connector
- Class 1, range up to 650 meters with chip antenna or up to 1km
- Industrial temperature range from -40°C to +85°C
- RoHS Compliant
- USB interface (USB 2.0 compatible)
- UART with bypass mode
- 6 x GPIO
- 1 x 8-bit AIO
- Support for 802.11 Coexistence
- Integrated iWRAP™ Bluetooth stack or HCI firmware

# 1 Ordering Information

| Firmware                              | U.FL Connector    | Internal chip antenna |
|---------------------------------------|-------------------|-----------------------|
| iWRAP 5.6 firmware, reel              | WT41u-E-AI56      | WT41u-A-AI56          |
| iWRAP 5.5 firmware, reel              | WT41u-E-AI55      | WT41u-A-AI55          |
| HCI firmware, BT2.1 + EDR, reel       | WT41u-E-HCI21001  | WT41u-A-HCI21001      |
| iWRAP 5.6 firmware with iAP, reel     | WT41u-E-AI56IAP   | WT41u-A-AI56IAP       |
| iWRAP 5.6 firmware, cut reel          | WT41u-E-AI56C     | WT41u-A-AI56C         |
| iWRAP 5.5 firmware, cut reel          | WT41u-E-AI55C     | WT41u-A-AI55C         |
| HCI firmware, BT2.1 + EDR, cut reel   | WT41u-E-HCI21001C | WT41u-A-HCI21001C     |
| iWRAP 5.6 firmware with iAP, cut reel | WT41u-E-AI56IAPC  | WT41u-A-AI56IAPC      |

**Table 1: Ordering information**

## 2 Pinout and Terminal Description

Pins 1 and 52 (GND)  
are not connected  
and have been  
removed

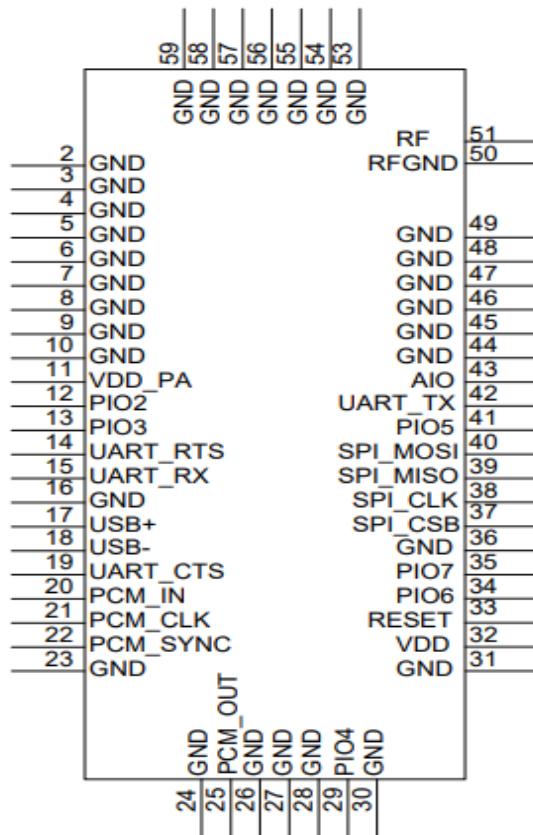


Figure 1: WT41u pin out

| Pad name | Pad number  | Pad type       | Description  |
|----------|---|----------------|--|
| NC       | 1, 52   | Not connected  | Pins 1 and 52 are not present on the footprint   |
| RESET    | 33  | Digital input  | Active low reset with weak internal pull-up. Keep low for >5ms to reset module   |
| GND      | 2-10, 16, 23, 24, 26-28, 30, 31, 36, 44-49, 53-59 | Ground         | Ground pads should all be connected to a ground plane with minimum trace length, especially on the antenna end of the module |
| RF       | 51  | Not connected  | No internal connection   |
| RFGND    | 50  | Ground         | Connect to ground plane  |
| VDD_PA   | 11  | Supply voltage | Supply voltage for the RF power amplifier and low noise amplifier  |
| VDD      | 32  | Supply voltage | Supply voltage for the Bluetooth chipset   |

**Table 2: Supply and RF Terminal Descriptions**

| PIO signal | Pad number | Description  |
|------------|------------|--|
| PIO[2]     | 12         | Bi-directional digital in/out with programmable strength and pull-up/pull-down |
| PIO[3]     | 13         | Bi-directional digital in/out with programmable strength and pull-up/pull-down |
| PIO[4]     | 29         | Bi-directional digital in/out with programmable strength and pull-up/pull-down |
| PIO[5]     | 41         | Bi-directional digital in/out with programmable strength and pull-up/pull-down |
| PIO[6]     | 34         | Bi-directional digital in/out with programmable strength and pull-up/pull-down |
| PIO[7]     | 35         | Bi-directional digital in/out with programmable strength and pull-up/pull-down |
| AIO[1]     | 43         | Bi-directional analog in/out   |

**Table 3: GPIO Terminal Descriptions**

| PCM signal | Pad number | Pad type                                | Description             |
|------------|------------|---|-------------------------|
| PCM_OUT    | 25         | Output, weak internal pull-down         | Synchronous data output |
| PCM_IN     | 20         | Input, weak internal pull-down          | Synchronous data input  |
| PCM_SYNC   | 22         | Bi-directional, weak internal pull-down | Synchronous data sync   |
| PCM_CLK    | 21         | Bi-directional, weak internal pull-down | Synchronous data clock  |

**Table 4: PCM Terminal Descriptions**

| UART signal | Pad number | Pad type                       | Description                      |
|-------------|------------|--------------------------------|----------------------------------|
| UART_TX     | 42         | Output, weak internal pull-up  | UART data output, active high    |
| UART_RTS#   | 14         | Output, weak internal pull-up  | UART request to send, active low |
| UART_RX     | 15         | Input, weak internal pull-down | UART data input, active high     |
| UART_CTS#   | 19         | Input, weak internal pull-down | UART clear to send, active low   |

**Table 5: UART Terminal Descriptions**

| USB signal | Pad number | Pad type      | Description                                 |
|------------|------------|---------------|---|
| USB+       | 17         | Bidirectional | USB data line with internal 1.5kohm pull-up |
| USB-       | 18         | Bidirectional | USB data line                               |

**Table 6: USB Terminal Descriptions**

| SPI signal | Pad number | Pad type                        | Description             |
|------------|------------|---------------------------------|-------------------------|
| SPI_MOSI   | 40         | Input, weak internal pull-down  | SPI data input          |
| SPI_CS#    | 37         | Input, weak internal pull-up    | Chip select, active low |
| SPI_CLK    | 38         | Input, weak internal pull-down  | SPI clock               |
| SPI_MISO   | 39         | Output, weak internal pull-down | SPI data output         |

**Table 7: Terminal Descriptions**

### 3 Electrical Characteristics

#### 3.1 Absolute Maximum Ratings

| Specification           | Min     | Max     | Unit |
|-------------------------|---------|---------|------|
| Storage temperature     | -40     | 85      | °C   |
| VDD_PA, VDD             | -0.4    | 3.7     | V    |
| Other terminal voltages | VSS-0.4 | VDD+0.4 | V    |

Table 8: Absolute Maximum Ratings

#### 3.2 Recommended Operating Conditions

| Specification         | Min | Max | Unit |
|-----------------------|-----|-----|------|
| Operating temperature | -40 | 85  | °C   |
| VDD_PA*, VDD          | 3.0 | 3.6 | V    |

\*) VDD\_PA has an effect on the RF output power.

Table 9: Recommended Operating Conditions

### 3.3 Input / Output Terminal Characteristics

#### 3.3.1 Input/Output Terminal Characteristics (Digital)

| Digital Terminals  |                               | Min       | Typ  | Max       |
|--|-------------------------------|-----------|------|-----------|
| <b>Input Voltage Levels</b>  |                               |           |      |           |
| $V_{IL}$ input logic level low   | 2.7 V $\leq$ VDD $\leq$ 3.0 V | -0.4      | -    | 0.8       |
|  | 1.7 V $\leq$ VDD $\leq$ 1.9 V | -0.4      | -    | 0.4       |
| $V_{IH}$ input logic level high  |                               | 0.7 VDD   | -    | VDD + 0.4 |
| <b>Output Voltage Levels</b>   |                               |           |      |           |
| $V_{OL}$ output logic level low<br>( $I_O = 4.0$ mA) 2.7V $\leq$ VDD $\leq$ 3.0 V  |                               | -         | -    | 0.2       |
| $V_{OL}$ output logic level low<br>( $I_{IO} = 4.0$ mA) 1.7V $\leq$ VDD $\leq$ 1.9 |                               | -         | -    | 0.4       |
| $V_{OL}$ output logic level high<br>( $I_O = 4.0$ mA) 2.7V $\leq$ VDD $\leq$ 3.0   |                               | VDD - 0.2 | -    |           |
| $V_{OL}$ output logic level high<br>( $I_O = 4.0$ mA) 1.7V $\leq$ VDD $\leq$ 1.9   |                               | VDD - 0.4 | -    |           |
| <b>Input and Tristate Current with</b>   |                               |           |      |           |
| Strong pull-up   |                               | -100      | -40  | -10       |
| Strong pull-down   |                               | 10        | 40   | 100       |
| Weak pull-up   |                               | -5.0      | -1.0 | -0.2      |
| Weak pull-down   |                               | 0.2       | 1.0  | 5.0       |
| I/O pad leakage current  |                               | -1        | 0    | 1         |
| $C_I$ input capacitance  |                               | 1.0       | -    | 5.0       |

### 3.3.2 Input/Output Terminal Characteristics (USB)

| USB Terminals                     | Min        | Typ | Max        | Unit |
|-----------------------------------|------------|-----|------------|------|
| VDD_USB for correct USB operation | 3.1        |     | 3.6        | V    |
| <b>Input Threshold</b>            |            |     |            |      |
| $V_{IL}$ input logic level low    | -          | -   | 0.3VDD_USB | V    |
| $V_{IH}$ input logic level high   | 0.7VDD_USB | -   | -          | V    |

### 3.4 PIO Current Sink and Source Capability

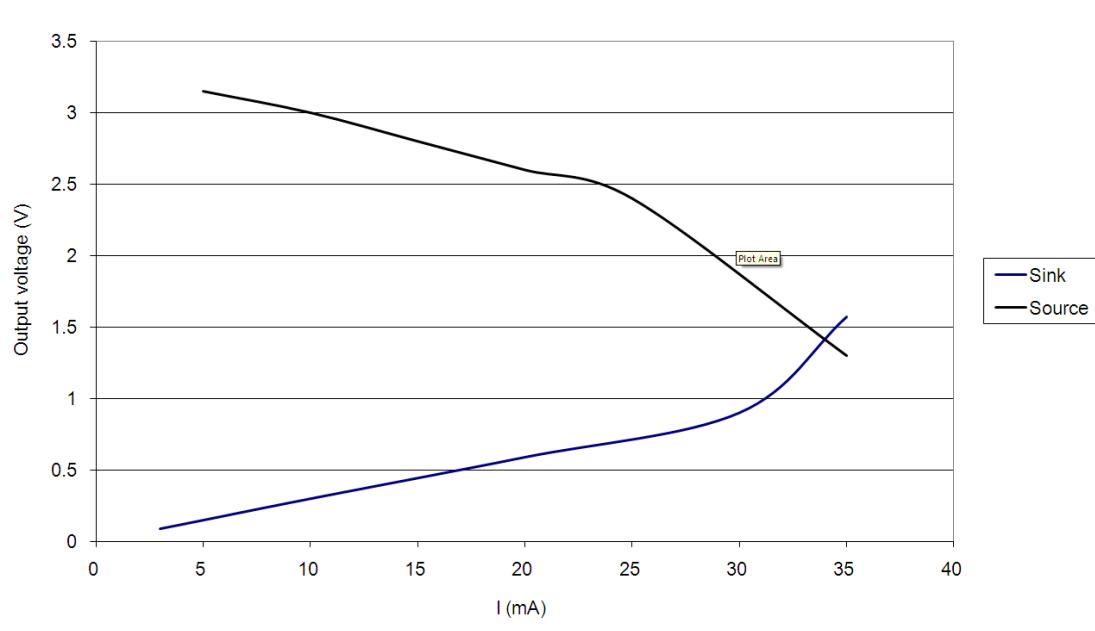


Figure 2: WT41u PIO Current Drive Capability

### 3.5 Transmitter Performance For BDR

| RF characteristic                                  | Min                       | Typ  | Max    | Bluetooth specification |
|--|---------------------------|------|--------|-------------------------|
| Max transmit power                                 | 17                        | 18.4 | 20     | <20                     |
| Transmit power variation over temperature range    |                           |      | +/-0.5 |                         |
| Transmit power variation over supply voltage range |                           |      |        |                         |
| Transmit power variation over frequency range      |                           | TBD  |        |                         |
| Transmit power control range                       | TBD                       |      | 18     |                         |
| 20dB bandwidth for modulated carrier               |                           | TBD  |        | <1000                   |
| ACP  | $F = F_0 \pm 2\text{MHz}$ |      | TBD    | -20                     |
|  | $F = F_0 \pm 3\text{MHz}$ |      | TBD    | -40                     |
|  | $F = F_0 > 3\text{MHz}$   |      | TBD    | -40                     |
| Drift rate   |                           | TBD  |        | $\pm 25$                |
| $\Delta F_{1\text{avg}}$                           |                           | TBD  |        | 140 to 175              |
| $\Delta F_{1\text{max}}$                           |                           | TBD  |        | 140 to 175              |
| $\Delta F_{2\text{avg}} / \Delta F_{1\text{avg}}$  |                           | TBD  |        | $\geq 0.8$              |

**Table 10: Transmitter performance for BDR (room temperature, VDD=3.3V)**

TBD

**Figure 3: Typical TX power as a function of VDD\_PA**

### 3.6 Receiver Performance

Antenna gain not taken into account

| Characteristic, VDD=3.3V, room temperature   | Packet type | Typ | Bluetooth specification | Unit |
|--|-------------|-----|-------------------------|------|
| Sensitivity for 0.1% BER                     | DH1         | TBD | -70                     | dBm  |
|  | DH5         | -92 |                         | dBm  |
|  | 2-DH1       | -97 |                         | dBm  |
|  | 2-DH5       | TBD |                         | dBm  |
|  | 3-DH1       | TBD |                         | dBm  |
|  | 3-DH5       | TBD |                         | dBm  |
| Sensitivity variation over temperature range |             | TBD |                         | dBm  |

**Table 11: Receiver sensitivity**

### 3.7 Current Consumption

| Operating mode        | Peak | Average | Unit |
|-----------------------|------|---------|------|
| Stand-by, page mode 0 |      | TBD     | mA   |
| TX 3-DH5              |      | TBD     | mA   |
| TX 2-DH5              |      | TBD     | mA   |
| TX DH5                |      | TBD     | mA   |
| RX                    |      | TBD     | mA   |
| Deep sleep            |      | TBD     | mA   |
| Inquiry               |      | TBD     | mA   |

**Table 12: Current consumption**

## 4 Physical Dimensions

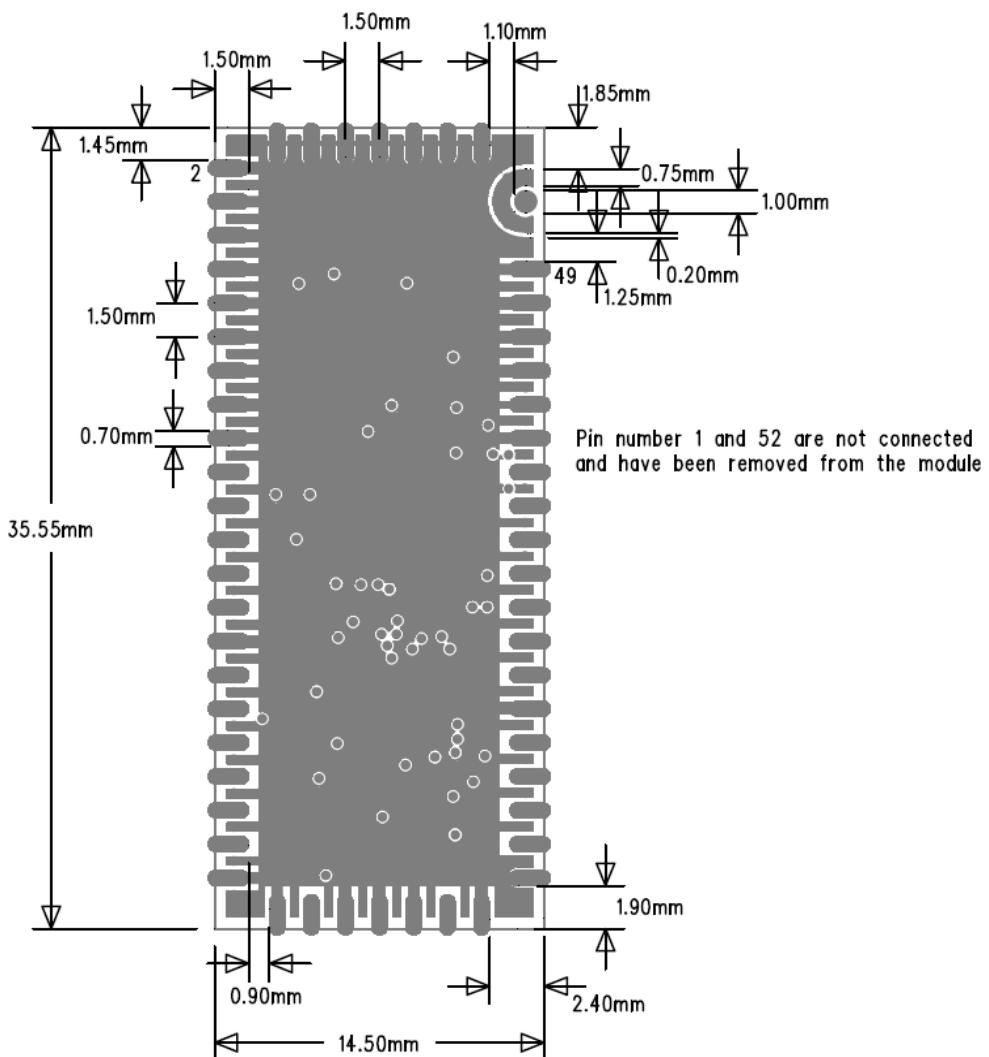


Figure 4: Physical dimensions (top view)

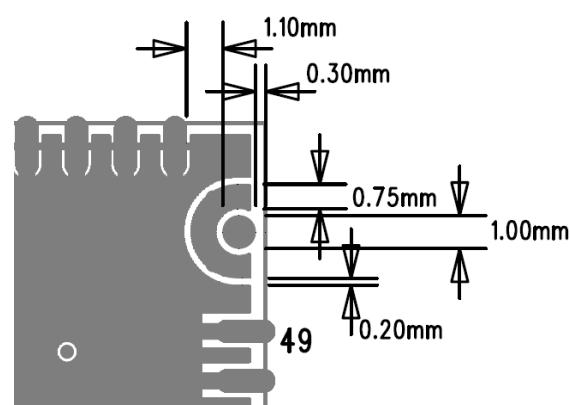
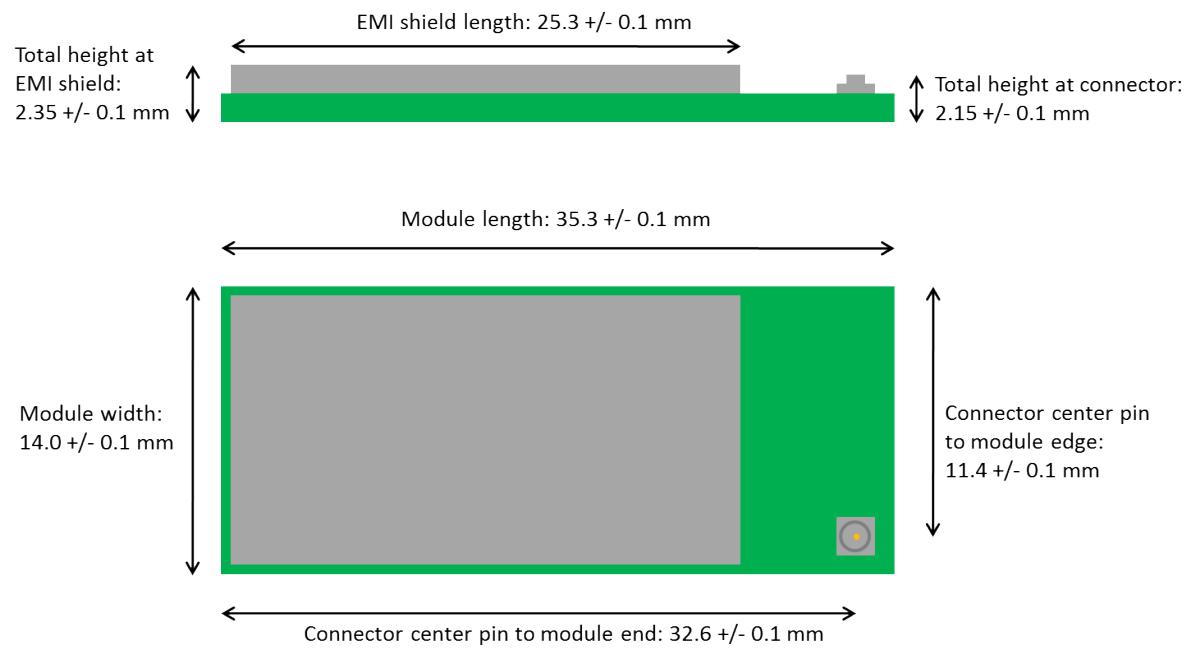
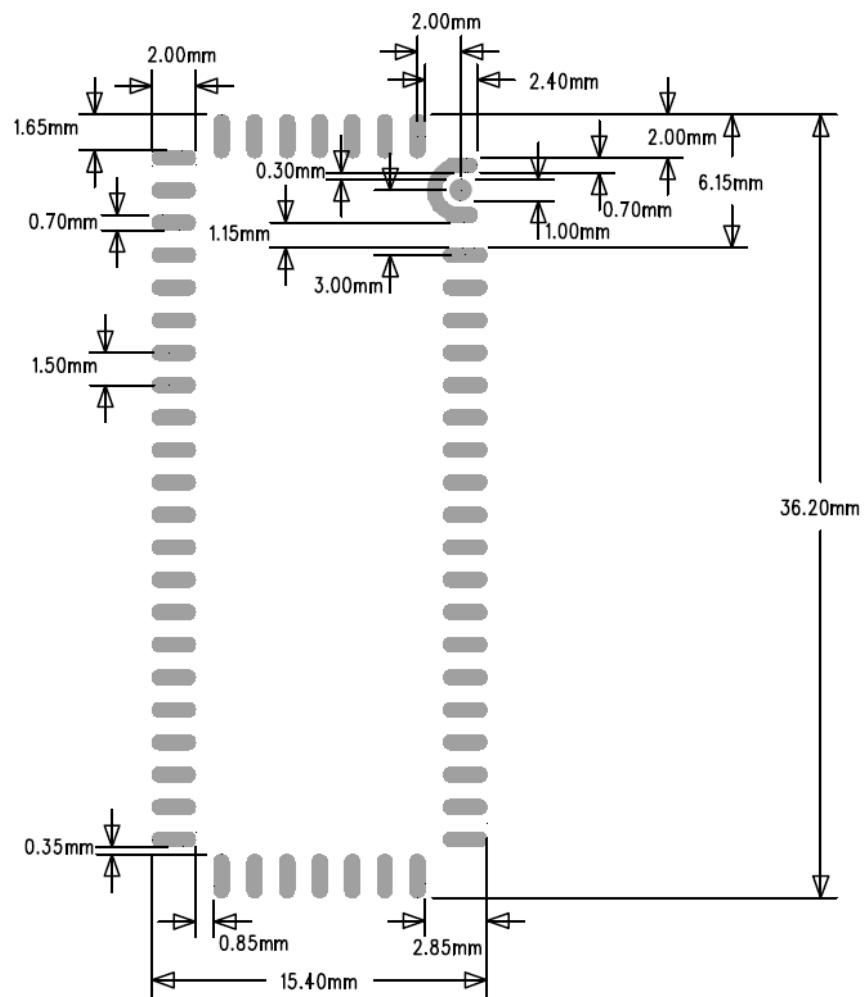


Figure 5: Dimensions for the RF pin used as antenna connection on WT41u-N (top view)



**Figure 6: Dimensions of WT41u**



**Figure 8: Recommended land pattern**

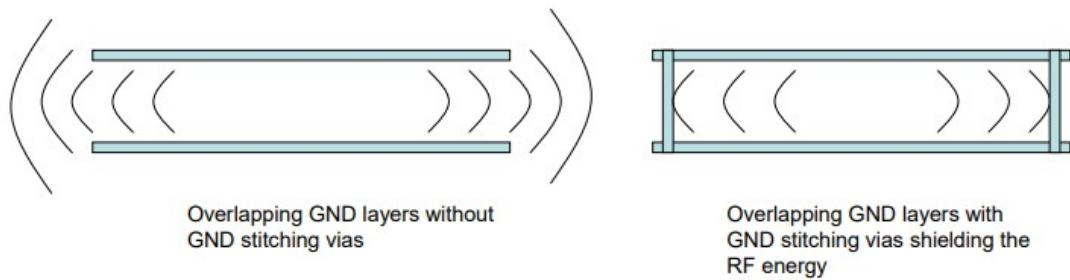
## 5 Layout Guidelines

Use good layout practices to avoid excessive noise coupling to supply voltage traces or sensitive analog signal traces, such as analog audio signals. If using overlapping ground planes use stitching vias separated by max 3 mm to avoid emission from the edges of the PCB. Connect all the GND pins directly to a solid GND plane and make sure that there is a low impedance path for the return current following the signal and supply traces all the way from start to the end.

A good practice is to dedicate one of the inner layers to a solid GND plane and one of the inner layers to supply voltage planes and traces and route all the signals on top and bottom layers of the PCB. This arrangement will make sure that any return current follows the forward current as close as possible and any loops are minimized.



**Figure 9:** Typical 4-layer PCB construction



**Figure 10:** Use of stitching vias to avoid emissions from the edges of the PCB

## 6 UART Interface

This is a standard UART interface for communicating with other serial devices. WT41u UART interface provides a simple mechanism for communicating with other serial devices using the RS232 protocol.

Four signals are used to implement the UART function. When WT41u is connected to another digital device, UART\_RX and UART\_TX transfer data between the two devices. The remaining two signals, UART\_CTS and UART\_RTS, can be used to implement RS232 hardware flow control where both are active low indicators. All UART connections are implemented using CMOS technology and have signalling levels of 0V and VDD.

UART configuration parameters, such as data rate and packet format, are set using WT41u software.

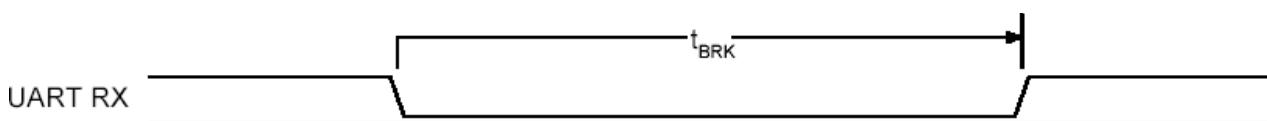
**Note:**

*In order to communicate with the UART at its maximum data rate using a standard PC, an accelerated serial port adapter card is required for the PC.*

| Parameter           | Possible values   |
|---------------------|-------------------|
| Data rate           | Minimum           |
|                     | Maximum           |
| Flow control        | RTS/CTS or None   |
| Parity              | None, Odd or Even |
| Number of stop bits | 1 or 2            |
| Bits per channel    | 8                 |

**Table 13: Possible UART Settings**

The UART interface is capable of resetting WT41u upon reception of a break signal. A break is identified by a continuous logic low (0V) on the UART\_RX terminal, as shown in Figure 10. If tBRK is longer than the value, defined by PSKEY\_HOST\_IO\_UART\_RESET\_TIMEOUT, (0x1a4), a reset will occur. This feature allows a host to initialise the system to a known state. Also, WT41u can emit a break character that may be used to wake the host.



**Figure 11: Break Signal**

Table 17 shows a list of commonly used data rates and their associated values for PSKEY\_UART\_BAUD\_RATE (0x204). There is no requirement to use these standard values. Any data rate within the supported range can be set in the PS Key according to the formula in Equation 1.

$$\text{Data Rate} = \frac{\text{PSKEY_UART_BAUDRATE}}{0.004096}$$

**Equation 1: Data Rate**

| Data rate [bits/s] | Persistent store value (Hex) | Error [bits/s] | Error [%] |
|--------------------|------------------------------|----------------|-----------|
| 1200               | 0x0005                       | 5              | 1.73      |
| 2400               | 0x000A                       | 10             | 1.73      |
| 4800               | 0x0014                       | 20             | 1.73      |
| 9600               | 0x0027                       | 39             | -0.82     |
| 19200              | 0x004F                       | 79             | 0.45      |
| 38400              | 0x009D                       | 157            | -0.18     |
| 57600              | 0x00EC                       | 236            | 0.03      |
| 76800              | 0x013B                       | 315            | 0.14      |
| 115200             | 0x01D8                       | 472            | 0.03      |
| 230400             | 0x03B0                       | 944            | 0.03      |
| 460800             | 0x075F                       | 1887           | -0.02     |
| 921600             | 0x0EBF                       | 3775           | 0         |
| 1382400            | 0x161E                       | 5662           | -0.01     |
| 1843200            | 0x1D7E                       | 7550           | 0         |
| 2764800            | 0x2C3D                       | 11325          | 0         |

**Table 14: Standard Data Rates**

## 6.1 UART Bypass

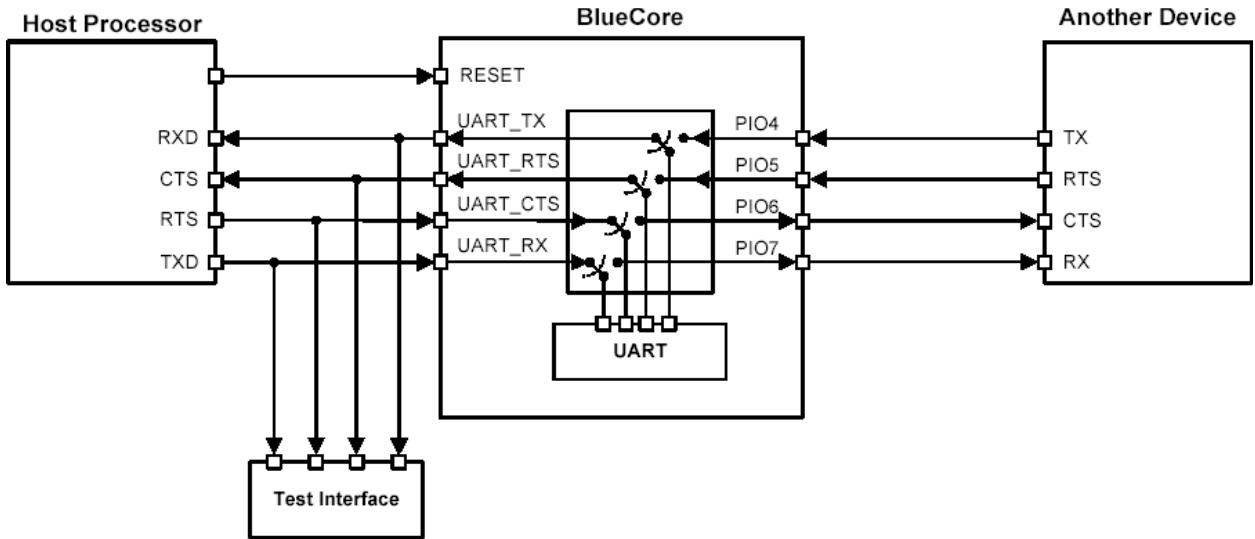


Figure 12: UART Bypass Architecture

## 6.2 UART Configuration While Reset is Active

The UART interface for WT41u while the chip is being held in reset is tristate. This will allow the user to daisy chain devices onto the physical UART bus. The constraint on this method is that any devices connected to this bus must tristate when WT41u reset is de-asserted and the firmware begins to run.

## 6.3 UART Bypass Mode

Alternatively, for devices that do not tristate the UART bus, the UART bypass mode on the chipset can be used. The default state of the chipset after reset is de-asserted; this is for the host UART bus to be connected to the chipset UART, thereby allowing communication to the chipset via the UART. All UART bypass mode connections are implemented using CMOS technology and have signalling levels of 0V and VDD.

In order to apply the UART bypass mode, a BCCMD command will be issued to the chipset. Upon this issue, it will switch the bypass to PIO[7:4] as Figure 11 indicates. Once the bypass mode has been invoked, WT41u will enter the Deep Sleep state indefinitely.

In order to re-establish communication with WT41u, the chip must be reset so that the default configuration takes effect.

It is important for the host to ensure a clean Bluetooth disconnection of any active links before the bypass mode is invoked. Therefore, it is not possible to have active Bluetooth links while operating the bypass mode.

The current consumption for a device in UART bypass mode is equal to the values quoted for a device in standby mode.

## 7 USB Interface

This is a full speed (12Mbits/s) USB interface for communicating with other compatible digital devices. WT41u acts as a USB peripheral, responding to requests from a master host controller such as a PC.

The USB interface is capable of driving a USB cable directly. No external USB transceiver is required. The device operates as a USB peripheral, responding to requests from a master host controller such as a PC. Both the OHCI and the UHCI standards are supported. The set of USB endpoints implemented can behave as specified in the USB section of the Bluetooth v2.1 + EDR specification or alternatively can appear as a set of endpoints appropriate to USB audio devices such as speakers.

As USB is a master/slave oriented system (in common with other USB peripherals), WT41u only supports USB Slave operation.

### 7.1 USB Data Connections

The USB data lines emerge as pins USB\_DP and USB\_DN. These terminals are connected to the internal USB I/O buffers of the the chipset, therefore, have a low output impedance. To match the connection to the characteristic impedance of the USB cable, resistors must be placed in series with USB\_DP/USB\_DN and the cable.

### 7.2 USB Pull-Up resistor

WT41u features an internal USB pull-up resistor. This pulls the USB\_DP pin weakly high when WT41u is ready to enumerate. It signals to the PC that it is a full speed (12Mbits/s) USB device.

The USB internal pull-up is implemented as a current source, and is compliant with section 7.1.5 of the USB specification v1.2. The internal pull-up pulls USB\_DP high to at least 2.8V when loaded with a  $15\text{k}\Omega$  5% pull-down resistor (in the hub/host) when  $\text{VDD\_PADS} = 3.1\text{V}$ . This presents a Thevenin resistance to the host of at least  $900\Omega$ . Alternatively, an external  $1.5\text{k}\Omega$  pull-up resistor can be placed between a PIO line and D+ on the USB cable. The firmware must be alerted to which mode is used by setting PSKEY\_USB\_PIO\_PULLUP appropriately. The default setting uses the internal pull-up resistor.

### 7.3 USB Power Supply

The USB specification dictates that the minimum output high voltage for USB data lines is 2.8V. To safely meet the USB specification, the voltage on the VDD supply terminal must be an absolute minimum of 3.1V. Silicon Labs recommends 3.3V for optimal USB signal quality.

### 7.4 Self-Powered Mode

In self-powered mode, the circuit is powered from its own power supply and not from the VBUS (5V) line of the USB cable. It draws only a small leakage current (below 0.5mA) from VBUS on the USB cable. This is the easier mode for which to design, as the design is not limited by the power that can be drawn from the USB hub or root port. However, it requires that VBUS be connected to WT41u via a resistor network ( $R_{vb1}$  and  $R_{vb2}$ ), so WT41u can detect when VBUS is powered up. The chipset will not pull USB\_DP high when VBUS is off.

Self-powered USB designs (powered from a battery or PSU) must ensure that a PIO line is allocated for USB pullup purposes. A  $1.5\text{k}\Omega$  5% pull-up resistor between USB\_DP and the selected PIO line should be fitted to the design. Failure to fit this resistor may result in the design failing to be USB compliant in self-powered mode. The internal pull-up in the chipset is only suitable for bus-powered USB devices, e.g., dongles.

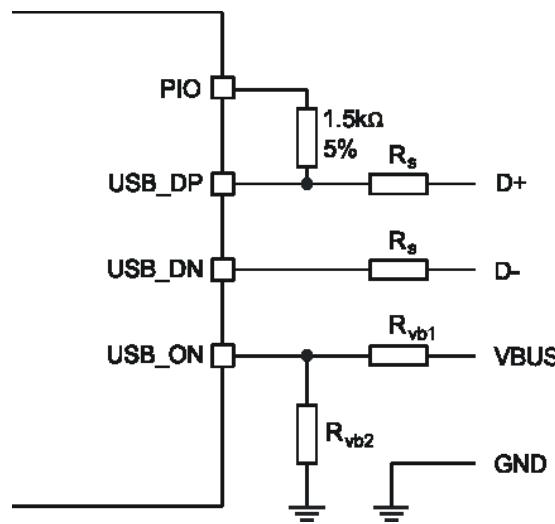


Figure 13: USB Connections for Self-Powered Mode

The terminal marked USB\_ON can be any free PIO pin. The PIO pin selected must be registered by setting PSKEY\_USB\_PIO\_VBUS to the corresponding pin number.

| Identifier | Value       | Function                        |
|------------|-------------|---------------------------------|
| $R_s$      | 27Ω nominal | Impedance matching to USB cable |
| $R_{vb1}$  | 22kΩ 5%     | VBUS ON sense divider           |
| $R_{vb2}$  | 47kΩ 5%     | VBUS ON sense divider           |

Figure 14: USB Interface Component Values

## 7.5 Bus-Powered Mode

In bus-powered mode, the application circuit draws its current from the 5V VBUS supply on the USB cable. WT41u negotiates with the PC during the USB enumeration stage about how much current it is allowed to consume. On power-up the device must not draw more than 100 mA but after being configured it can draw up to 500 mA.

For WT41u, the USB power descriptor should be altered to reflect the amount of power required. This is accomplished by setting PSKEY\_USB\_MAX\_POWER (0x2c6). This is higher than for a Class 2 application due to the extra current drawn by the Transmit RF PA. By default for WT41u the setting is 300 mA.

When selecting a regulator, be aware that VBUS may go as low as 4.4V. The inrush current (when charging reservoir and supply decoupling capacitors) is limited by the USB specification. See the USB Specification. Some applications may require soft start circuitry to limit inrush current if more than 10uF is present between VBUS and GND. The 5V VBUS line emerging from a PC is often electrically noisy. As well as regulation down to 3.3V and 1.8V, applications should include careful filtering of the 5V line to attenuate noise that is above the voltage regulator bandwidth. Excessive noise on WT41u supply pins will result in reduced receiver sensitivity and a distorted RF transmit signal.

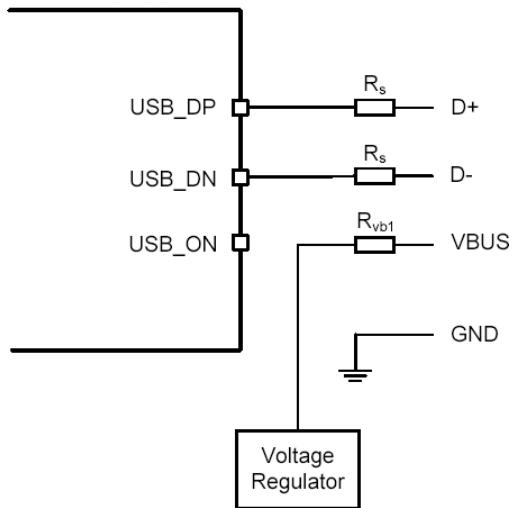


Figure 15: USB Connections for Bus-Powered Mode

## 7.6 USB Suspend Current

All USB devices must permit the USB controller to place them in a USB suspend mode. While in USB Suspend, bus-powered devices must not draw more than 2.5mA from USB VBUS (self-powered devices may draw more than 2.5mA from their own supply). This current draw requirement prevents operation of the radio by bus-powered devices during USB Suspend.

When computing suspend current, the current from VBUS through the bus pull-up and pull-down resistors must be included. The pull-up resistor at the device is 1.5 kΩ. (nominal). The pull-down resistor at the hub is 14.25kΩ. to 24.80kΩ. The pull-up voltage is nominally 3.3V, which means that holding one of the signal lines high takes approximately 200uA, leaving only 2.3mA available from a 2.5mA budget. Ensure that external LEDs and/or amplifiers can be turned off by the chipset. The entire circuit must be able to enter the suspend mode.

## 7.7 USB Detach and Wake-Up Signaling

WT41u can provide out-of-band signaling to a host controller by using the control lines called USB\_DETACH and USB\_WAKE\_UP. These are outside the USB specification (no wires exist for them inside the USB cable), but can be useful when embedding WT41u into a circuit where no external USB is visible to the user. Both control lines are shared with PIO pins and can be assigned to any PIO pin by setting PSKEY\_USB\_PIO\_DETACH and PSKEY\_USB\_PIO\_WAKEUP to the selected PIO number.

USB\_DETACH is an input which, when asserted high, causes WT41u to put USB\_DN and USB\_DP in high impedance state and turns off the pull-up resistor on DP. This detaches the device from the bus and is logically equivalent to unplugging the device. When USB\_DETACH is taken low, WT41u will connect back to USB and await enumeration by the USB host.

USB\_WAKE\_UP is an active high output (used only when USB\_DETACH is active) to wake up the host and allow USB communication to recommence. It replaces the function of the software USB\_WAKE\_UP message (which runs over the USB cable) and cannot be sent while the chipset is effectively disconnected from the bus.

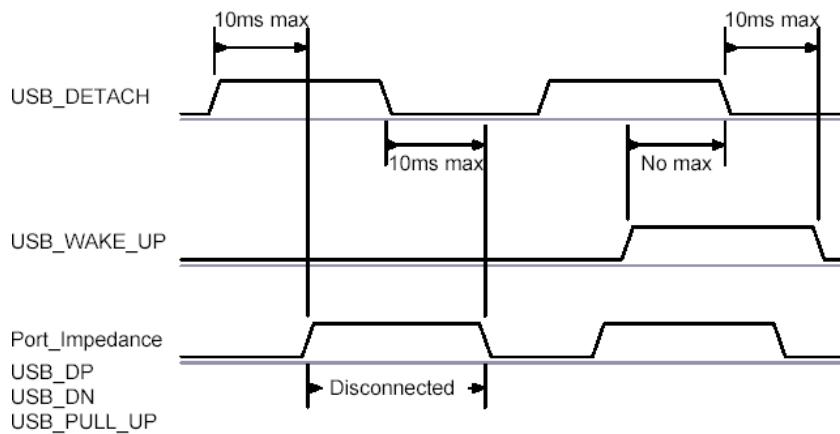


Figure 16: USB\_Detach and USB\_Wake\_Up Signals

## 7.8 USB Driver

A USB Bluetooth device driver is required to provide a software interface between the chipset and Bluetooth software running on the host computer. Please, contact Silicon Labs support at <http://www.silabs.com> for suitable drivers.

## 7.9 USB v2.0 Compliance and Compatibility

Although WT41u meets the USB specification, Silicon Labs cannot guarantee that an application circuit designed around the module is USB compliant. The choice of application circuit, component choice and PCB layout all affect USB signal quality and electrical characteristics. The information in this document is intended as a guide and should be read in association with the USB specification, with particular attention being given to Chapter 7. Independent USB qualification must be sought before an application is deemed USB compliant and can bear the USB logo. Such qualification can be obtained from a USB plugfest or from an independent USB test house.

Terminals USB\_DP and USB\_DN adhere to the USB Specification v2.0 (Chapter 7) electrical requirements.

The chipset is compatible with USB v2.0 host controllers; under these circumstances the two ends agree the mutually acceptable rate of 12Mbits/s according to the USB v2.0 specification.

## 8 Serial Peripheral Interface (SPI)

The SPI port can be used for system debugging. It can also be used for programming the Flash memory and setting the PSKEY configurations. WT41u uses 16-bit data and 16-bit address serial peripheral interface, where transactions may occur when the internal processor is running or is stopped. SPI interface is connected using the MOSI, MISO, CSB and CLK pins. Please, contact the Silicon Labs support at <http://www.silabs.com> for detailed information about the instruction cycle.

## 9 PCM Codec Interface

PCM is a standard method used to digitize audio (particularly voice) for transmission over digital communication channels. Through its PCM interface, WT41u has hardware support for continual transmission and reception of PCM data, thus reducing processor overhead for wireless headset applications. WT41u offers a bidirectional digital audio interface that routes directly into the baseband layer of the on-chip firmware. It does not pass through the HCI protocol layer.

Hardware on WT41u allows the data to be sent to and received from a SCO connection. Up to three SCO connections can be supported by the PCM interface at any one time.

WT41u can operate as the PCM interface master generating an output clock of 128, 256 or 512kHz. When configured as PCM interface slave, it can operate with an input clock up to 2048kHz. WT41u is compatible with a variety of clock formats, including Long Frame Sync, Short Frame Sync and GCI timing environments.

It supports 13-bit or 16-bit linear, 8-bit  $\mu$ -law or A-law companded sample formats at 8ksamples/s and can receive and transmit on any selection of three of the first four slots following PCM\_SYNC. The PCM configuration options are enabled by setting PSKEY\_PCM\_CONFIG32.

WT41u interfaces directly to PCM audio devices.

*NOTE: Analog audio lines are very sensitive to RF disturbance. Use good layout practices to ensure noise less audio. Make sure that the return path for the audio signals follows the forward current all the way as close as possible and use fully differential signals when possible. Do not compromise audio routing.*

### 9.1 PCM Interface Master/Slave

When configured as the master of the PCM interface, WT41u generates PCM\_CLK and PCM\_SYNC.

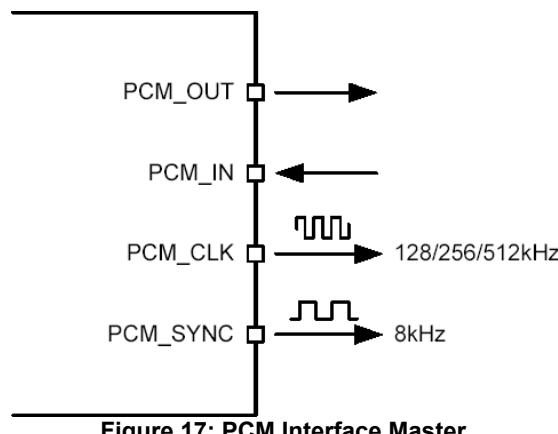


Figure 17: PCM Interface Master

When configured as the Slave of the PCM interface, WT41u accepts PCM\_CLK rates up to 2048kHz.

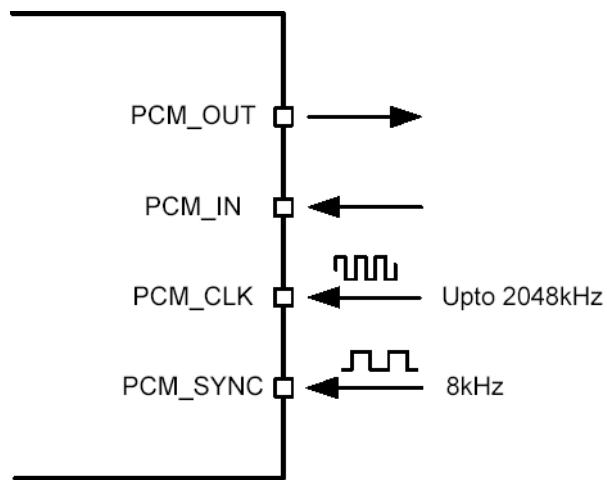


Figure 18: PCM Interface Slave

## 9.2 Long Frame Sync

Long Frame Sync is the name given to a clocking format that controls the transfer of PCM data words or samples. In Long Frame Sync, the rising edge of PCM\_SYNC indicates the start of the PCM word. When WT41u is configured as PCM master, generating PCM\_SYNC and PCM\_CLK, then PCM\_SYNC is 8-bits long. When WT41u is configured as PCM Slave, PCM\_SYNC may be from two consecutive falling edges of PCM\_CLK to half the PCM\_SYNC rate, i.e., 62.5s long.

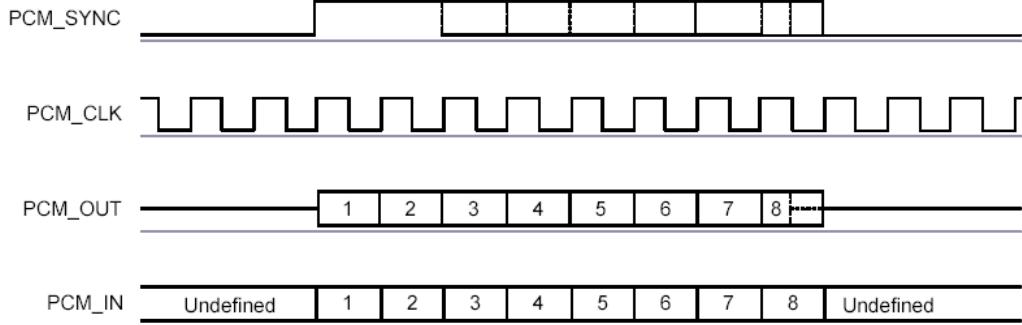
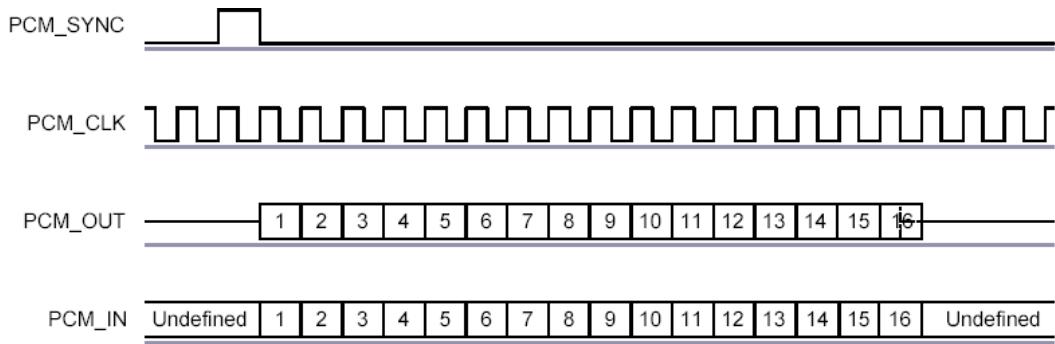


Figure 19: Long Frame Sync (Shown with 8-bit Companded Sample)

WT41u samples PCM\_IN on the falling edge of PCM\_CLK and transmits PCM\_OUT on the rising edge. PCM\_OUT may be configured to be high impedance on the falling edge of PCM\_CLK in the LSB position or on the rising edge.

## 9.3 Short Frame Sync

In Short Frame Sync, the falling edge of PCM\_SYNC indicates the start of the PCM word. PCM\_SYNC is always one clock cycle long.

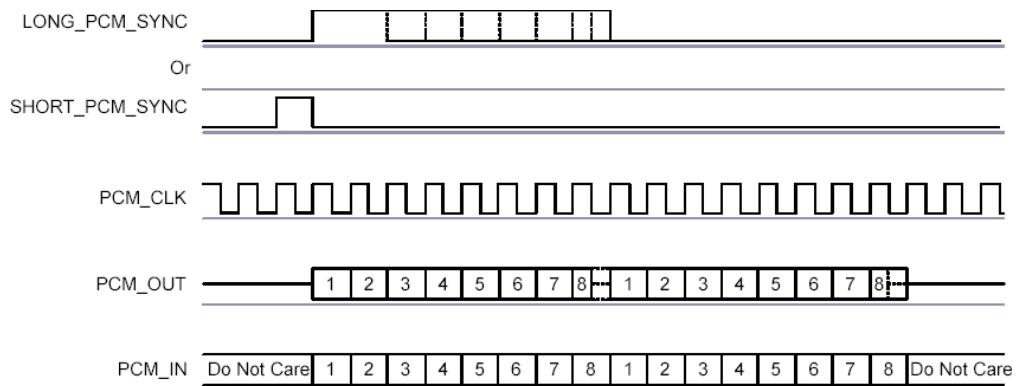


**Figure 20: Short Frame Sync (Shown with 16-bit Sample)**

As with Long Frame Sync, WT41u samples PCM\_IN on the falling edge of PCM\_CLK and transmits PCM\_OUT on the rising edge. PCM\_OUT may be configured to be high impedance on the falling edge of PCM\_CLK in the LSB position or on the rising edge.

## 9.4 Multi-slot Operation

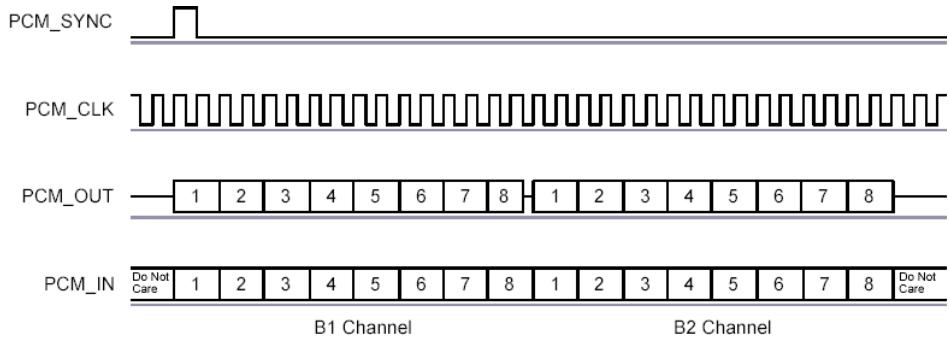
More than one SCO connection over the PCM interface is supported using multiple slots. Up to three SCO connections can be carried over any of the first four slots.



**Figure 21: Multi-slot Operation with Two Slots and 8-bit Companded Samples**

## 9.5 GCI Interface

WT41u is compatible with the GCI, a standard synchronous 2B+D ISDN timing interface. The two 64kbit/s B channels can be accessed when this mode is configured.



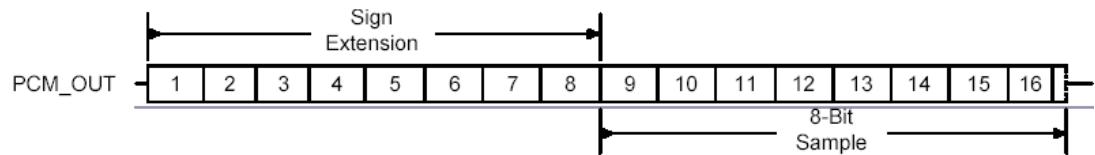
**Figure 22: GCI Interface**

The start of frame is indicated by the rising edge of PCM\_SYNC and runs at 8kHz. With WT41u in Slave mode, the frequency of PCM\_CLK can be up to 4.096MHz.

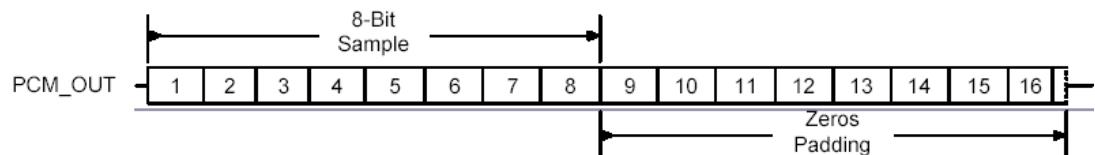
## 9.6 Slots and Sample Formats

WT41u can receive and transmit on any selection of the first four slots following each sync pulse. Slot durations can be either 8 or 16 clock cycles. Durations of 8 clock cycles may only be used with 8-bit sample formats. Durations of 16 clocks may be used with 8-bit, 13-bit or 16-bit sample formats.

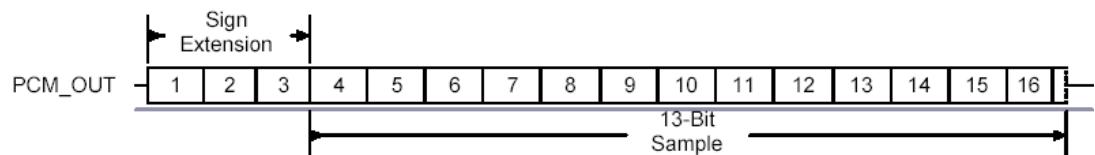
WT41u supports 13-bit linear, 16-bit linear and 8-bit -law or A-law sample formats. The sample rate is 8ksamples/s. The bit order may be little or big endian. When 16-bit slots are used, the 3 or 8 unused bits in each slot may be filled with sign extension, padded with zeros or a programmable 3-bit audio attenuation compatible with some Motorola codecs.



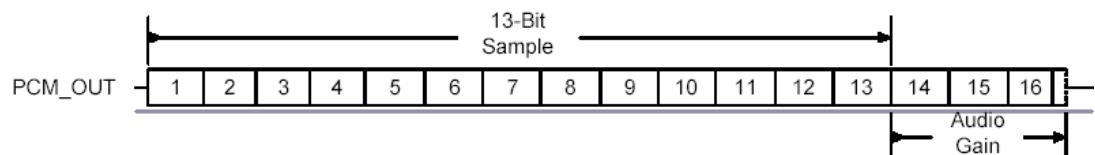
A 16-bit slot with 8-bit compounded sample and sign extension selected.



A 16-bit slot with 8-bit compounded sample and zeros padding selected.



A 16-bit slot with 13-bit linear sample and sign extension selected.



A 16-bit slot with 13-bit linear sample and audio gain selected.

**Figure 23: 16-bit Slot Length and Sample Formats**

## 9.7 Additional Features

WT41u has a mute facility that forces PCM\_OUT to be 0. In master mode, PCM\_SYNC may also be forced to 0 while keeping PCM\_CLK running which some codecs use to control power down.

## 9.8 PCM\_CLK and PCM\_SYNC Generation

WT41u has two methods of generating PCM\_CLK and PCM\_SYNC in master mode. The first is generating these signals by DDS from the chipset internal 4MHz clock. Using this mode limits PCM\_CLK to 128, 256 or 512kHz and PCM\_SYNC to 8kHz. The second is generating PCM\_CLK and PCM\_SYNC by DDS from an internal 48MHz clock (which allows a greater range of frequencies to be generated with low jitter but consumes more power). This second method is selected by setting bit 48M\_PCM\_CLK\_GEN\_EN in PSKEY\_PCM\_CONFIG32. When in this mode and with long frame sync, the length of PCM\_SYNC can be either 8 or 16 cycles of PCM\_CLK, determined by LONG\_LENGTH\_SYNC\_EN in PSKEY\_PCM\_CONFIG32.

The Equation 2 describes PCM\_CLK frequency when being generated using the internal 48MHz clock:

$$f = \frac{\text{CNT\_RATE}}{\text{CNT\_LIMIT}} \times 24\text{MHz}$$

**Equation 2: PCM\_CLK Frequency When Being Generated Using the Internal 48MHz Clock**

The frequency of PCM\_SYNC relative to PCM\_CLK can be set using Equation 3:

$$f = \frac{\text{PCM\_CLK}}{\text{SYNC\_LIMIT} \times 8}$$

**Equation 3: PCM\_SYNC Frequency Relative to PCM\_CLK**

CNT\_RATE, CNT\_LIMIT and SYNC\_LIMIT are set using PSKEY\_PCM\_LOW\_JITTER\_CONFIG. As an example, to generate PCM\_CLK at 512kHz with PCM\_SYNC at 8kHz, set PSKEY\_PCM\_LOW\_JITTER\_CONFIG to 0x08080177.

## 9.9 PCM Configuration

The PCM configuration is set using two PS Keys, PSKEY\_PCM\_CONFIG32 detailed in Table 18 and PSKEY\_PCM\_LOW\_JITTER\_CONFIG in Table 19. The default for PSKEY\_PCM\_CONFIG32 is 0x00800000, i.e., first slot following sync is active, 13-bit linear voice format, long frame sync and interface master generating 256kHz PCM\_CLK from 4MHz internal clock with no tri-state of PCM\_OUT.

| Name                       | Bit position | Description  |
|----------------------------|--------------|--|
| -                          | 0            | Set to 0   |
| SLAVE MODE EN              | 1            | 0 selects Master mode with internal generation of PCM_CLK and PCM_SYNC. 1 selects Slave mode requiring externally generated PCM_CLK and PCM_SYNC. This should be set to 1 if 48M_PCM_CLK_GEN_EN (bit 11) is set. |
| SHORT SYNC EN              | 2            | 0 selects long frame sync (rising edge indicates start of frame),  |
| -                          | 3            | Set to 0   |
| SIGN EXTENDED EN           | 4            | 0 selects long frame sync (rising edge indicates start of frame), 1 selects short frame sync (falling edge indicates start of frame).  |
| LSB FIRST EN               | 5            | 0 transmits and receives voice samples MSB first, 1 uses LSB   |
| TX TRISTATE EN             | 6            | 0 transmits and receives voice samples MSB first, 1 uses LSB   |
| TX TRISTATE RISING EDGE EN | 7            | 0 tristates PCM_OUT immediately after the falling edge of PCM_CLK in the last bit of an active slot, assuming the next slot is also not active. 1 tristates PCM_OUT after the rising edge of PCM_CLK.            |
| SYNC SUPPRESS EN           | 8            | 0 enables PCM_SYNC output when master, 1 suppresses PCM_SYNC whilst keeping PCM_CLK running. Some CODECS utilize this to enter a low power state   |
| GCI MODE EN                | 9            | 1 enables GCI mode.  |
| MUTE EN                    | 10           | 1 forces PCM_OUT to 0.   |
| 48M PCM CLK GEN EN         | 11           | 0 sets PCM_CLK and PCM_SYNC generation via DDS from internal 4 MHz clock. 1 sets PCM_CLK and PCM_SYNC generation via DDS from internal 48 MHz clock.   |
| LONG LENGTH SYNC EN        | 12           | 0 sets PCM_SYNC length to 8 PCM_CLK cycles and 1 sets length to 16 PCM_CLK cycles. Only applies for long frame sync and with 48M_PCM_CLK_GEN_EN set to 1.  |
| -                          | [20:16]      | Set to 0b00000.  |
| MASTER CLK RATE            | [22:21]      | Selects 128 (0b01), 256 (0b00), 512 (0b10) kHz PCM_CLK frequency when master and 48M_PCM_CLK_GEN_EN (bit 11) is low.   |
| ACTIVE SLOT                | [26:23]      | Default is 0001. Ignored by firmware   |
| SAMPLE FORMAT              | [28:27]      | Selects between 13 (0b00), 16 (0b01), 8 (0b10) bit sample with 16 cycle slot duration 8 (0b11) bit sample 8 cycle slot duration.   |

Table 15: PSKEY\_PCM\_CONFIG32 description

| Name       | Bit position | Description                                |
|------------|--------------|--|
| CNT LIMIT  | [12:0]       | Sets PCM_CLK counter limit                 |
| CNT RATE   | [23:16]      | Sets PCM_CLK count rate                    |
| SYNC LIMIT | [31:24]      | Sets PCM_SYNC division relative to PCM_CLK |

**Table 16: PSKEY\_PCM\_LOW\_JITTER\_CONFIG Description**

## 10 I/O Parallel Ports

Six lines of programmable bidirectional input/outputs (I/O) are provided. All the PIO lines are power from VDD.

PIO lines can be configured through software to have either weak or strong pull-ups or pull-downs. All PIO lines are configured as inputs with weak pull-downs at reset. Any of the PIO lines can be configured as interrupt request lines or as wake-up lines from sleep modes.

WT41u has a general purpose analogue interface pin AIO[1]. This is used to access internal circuitry and control signals. It may be configured to provide additional functionality.

Auxiliary functions available via AIO[1] include an 8-bit ADC and an 8-bit DAC. Typically the ADC is used for battery voltage measurement. Signals selectable at this pin include the band gap reference voltage and a variety of clock signals: 48, 24, 16, 8MHz and the XTAL clock frequency. When used with analogue signals, the voltage range is constrained by the analogue supply voltage internally to the module (1.8V). When configured to drive out digital level signals (e.g., clocks), the output voltage level is determined by VDD.

### 10.1 PIO Defaults

Silicon Labs cannot guarantee that these terminal functions remain the same. Refer to the software release note for the implementation of these PIO lines, as they are firmware build-specific.

## 11 Reset

WT41u may be reset from several sources: RESET pin, power on reset, a UART break character or via software configured watchdog timer. The RESET pin is an active low reset and is internally filtered using the internal low frequency clock oscillator. A reset will be performed between 1.5 and 4.0ms following RESETB being active. It is recommended that RESET be applied for a period greater than 5ms.

The power on reset occurs when the VDD\_CORE supply internally to the module falls below typically 1.5V and is released when VDD\_CORE rises above typically 1.6V. At reset the digital I/O pins are set to inputs for bidirectional pins and outputs are tri-state.

The reset should be held active at power up until all the supply voltages have stabilized to ensure correct operation of the internal flash memory. Following figure shows an example of a simple power up reset circuit. Time constant of the RC circuitry is set so that the supply voltage is safely stabilized before the reset deactivates.

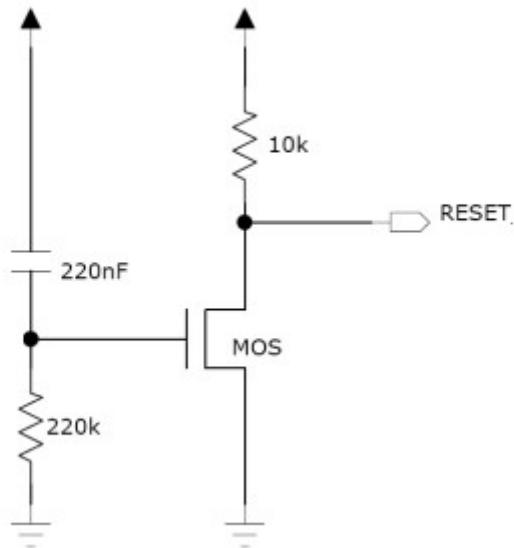


Figure 24: Example of a simple power on reset circuit.

## 11.1 Pin States on Reset

| Pad name | State                   |
|----------|-------------------------|
| PIO[7:2] | Input, weak pull-down   |
| PCM_OUT  | 3-state, weak pull-down |
| PCM_IN   | Input, weak pull-down   |
| PCM_SYNC | Input, weak pull-down   |
| PCM_CLK  | Input, weak pull-down   |
| UART_TX  | 3-state, weak pull-up   |
| UART_RX  | Input, weak pull-down   |
| UART_RTS | 3-state, weak pull-up   |
| UART_CTS | Input, weak pull-down   |
| USB+     | Input, weak pull-down   |
| USB-     | Input, weak pull-down   |
| SPI_CSB  | Input, weak pull-down   |
| SPI_CLK  | Input, weak pull-down   |
| SPI_MOSI | Input, weak pull-down   |
| SPI_MISO | 3-state, weak pull-down |
| AIO[1]   | Output, driving low     |

Table 17: Pin States on Reset

## 12 Certifications

### 12.1 Bluetooth

The WT41u module is Bluetooth qualified and listed as a controller subsystem and it is Bluetooth compliant to the following profiles of the core spec version 2.1/2.1+EDR.

- Baseband
- HCI
- Link Manager
- Radio

### 12.2 FCC

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) this device may not cause harmful interference, and
- (2) this device must accept any interference received, including interference that may cause undesired operation.

Any changes or modifications not expressly approved by trafficnow could void the user's authority to operate the equipment.

#### **FCC RF Radiation Exposure Statement:**

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. End users must follow the specific operating instructions for satisfying RF exposure compliance. This transmitter meets both portable and mobile limits as demonstrated in the RF Exposure Analysis. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter except in accordance with FCC multi-transmitter product procedures.

As long as the condition above is met, further transmitter testing will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.).

#### **OEM Responsibilities to comply with FCC Regulations**

The WT41U Module has been certified for integration into products only by OEM integrators under the following conditions:

- The antenna(s) must be installed such that a minimum separation distance of 42 mm is maintained between the radiator (antenna) and all persons at all times.

- The transmitter module must not be co-located or operating in conjunction with any other antenna or transmitter except in accordance with FCC multi-transmitter product procedures.

As long as the two conditions above are met, further transmitter testing will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.).

**IMPORTANT NOTE:** In the event that these conditions cannot be met (for certain configurations or co-location with another transmitter), then the FCC authorization is no longer considered valid and the FCC ID cannot be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

### **End Product Labeling**

The WT41U module is labeled with its own FCC ID. If the FCC ID is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. In that case, the final end product must be labeled in a visible area with the following:

**“Contains Transmitter Module FCC ID: 2A3TOTFNBDS01” or**

**“Contains FCC ID: 2A3TOTFNBDS01**

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module or change RF related parameters in the user manual of the end product

## **12.3 ISEDC**

This radio transmitter (IC: 28130-TFNDBS01) has been approved by Industry Canada to operate with the embedded chip antenna and the antennas listed in the table 18. Other antenna types are strictly prohibited for use with this device.

This device complies with Industry Canada's license-exempt RSS standards. Operation is subject to the following two conditions:

- (1) This device may not cause interference; and
- (2) This device must accept any interference, including interference that may cause undesired operation of the device

### **RF Exposure Statement**

Exception from routine SAR evaluation limits are given in RSS-102 Issue5. WT41U meets the given requirements when the minimum separation distance to human body is less than equal to 40 mm. RF exposure or SAR evaluation is not required when the separation distance is 40 mm or more. If the separation distance is less than 40 mm the OEM integrator is responsible for evaluating the SAR.

### **OEM Responsibilities to comply with IC Regulations**

The WT41U Module has been certified for integration into products only by OEM integrators under the following conditions:

- The antenna(s) must be installed such that a minimum separation distance of 40 mm is maintained between the radiator (antenna) and all persons at all times.

- The transmitter module must not be co-located or operating in conjunction with any other antenna or transmitter.

As long as the two conditions above are met, further transmitter testing will not be required. However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.).

**IMPORTANT NOTE:** In the event that these conditions cannot be met (for certain configurations or co-location with another transmitter), then the IC authorization is no longer considered valid and the IC ID cannot be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate IC authorization

### **End Product Labeling**

The WT41U module is labeled with its own IC ID. If the IC ID is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. In that case, the final end product must be labeled in a visible area with the following:

**“Contains Transmitter Module IC: 28130-TFNDBS01” or**

**“Contains IC: 28130-TFNDBS01**

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module or change RF related parameters in the user manual of the end product

### **12.3.1 IC (français)**

Cet émetteur radio (IC : 28130-TFNDBS01) a reçu l'approbation d'Industrie Canada pour une exploitation avec l'antenne puce incorporée. Il est strictement interdit d'utiliser d'autres types d'antenne avec cet appareil.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes :

- 1) l'appareil ne doit pas produire de brouillage;
- 2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

### **Déclaration relative à l'exposition aux radiofréquences (RF)**

Les limites applicables à l'exemption de l'évaluation courante du DAS sont énoncées dans le CNR 102, 5<sup>e</sup> édition. L'appareil WT41U répond aux exigences données quand la distance de séparation minimum par rapport au corps humain est inférieure ou égale à 40 mm. L'évaluation de l'exposition aux RF ou du DAS n'est pas requise quand la distance de séparation est de 40 mm ou plus. Si la distance de séparation est inférieure à 40 mm, il incombe à l'intégrateur FEO d'évaluer le DAS.

### **Responsabilités du FEO ayant trait à la conformité avec les règlements IC**

Le module WT41U a été certifié pour une intégration dans des produits uniquement par les intégrateurs FEO dans les conditions suivantes :

- La ou les antennes doivent être installées de telle façon qu'une distance de séparation minimum de 40 mm soit maintenue entre le radiateur (antenne) et toute personne à tout moment.

- Le module émetteur ne doit pas être installé au même endroit ou fonctionner conjointement avec toute autre antenne ou émetteur.

Dès lors que les deux conditions ci-dessus sont respectées, d'autres tests de l'émetteur ne sont pas obligatoires. Cependant, il incombe toujours à l'intégrateur FEO de tester la conformité de son produit final vis-à-vis de toute exigence supplémentaire avec ce module installé (par exemple, émissions de dispositifs numériques, exigences relatives aux matériels périphériques PC, etc).

**REMARQUE IMPORTANTE :** S'il s'avère que ces conditions ne peuvent être respectées (pour certaines configurations ou la colocation avec un autre émetteur), alors l'autorisation IC n'est plus considérée comme valide et l'identifiant IC ne peut plus être employé sur le produit final. Dans ces circonstances, l'intégrateur FEO aura la responsabilité de réévaluer le produit final (y compris l'émetteur) et d'obtenir une autorisation IC distincte.

### **Étiquetage du produit final**

L'étiquette du module WT41U porte son propre identifiant IC. Si l'identifiant IC n'est pas visible quand le module est installé à l'intérieur d'un autre appareil, l'extérieur de l'appareil dans lequel le module est installé doit aussi porter une étiquette faisant référence au module qu'il contient. Dans ce cas, une étiquette comportant les informations suivantes doit être collée sur une partie visible du produit final :

« **Contient le module émetteur IC : 28130-TFNDBS01** » ou

« **Contient IC : 28130-TFNDBS01** »

L'intégrateur FEO doit être conscient de ne pas fournir d'informations à l'utilisateur final permettant d'installer ou de retirer ce module RF ou de changer les paramètres liés aux RF dans le mode d'emploi du produit final.

## 12.4 Qualified Antenna Types for WT41u

This device has been designed to operate with a 12 dBi MIMO 2x2 antenna. Any antenna of a different type or with a gain higher than 12 dBi is strictly prohibited for use with this device. Using an antenna of a different type or gain more than 12 dBi will require additional testing for FCC, CE and IC. The required antenna impedance is 50 Ω.

| Antenna type | Maximum gain |
|--------------|--------------|
| MIMO 2x2     | 12 dBi       |

**Table 18:** Qualified Antenna Types for WT41u

To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (EIRP) is not more than that permitted for successful communication.

Any standard 12 dBi MIMO 2x2 antenna can be used without an additional application to FCC.

## 12.5 Moisture Sensitivity Level (MSL)

Moisture sensitivity level (MSL) of this product is 3. For the handling instructions please refer to JEDEC J-STD-020 and JEDEC J-STD-033.

If baking is required, devices may be baked for 12 hours at 125°C +/-5°C for high temperature device containers.